

# Performance Analysis of FICA and PIFA Antenna with LNA Co-Design

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## ABSTRACT

Smart Dust Wireless Sensor Networks (SDWSNs), which are the members of Wireless Sensor Network (WSN) family play a vital role as the requirements on communication node sizes and power consumption have become more stringent. Several low volume antennas have been designed and Low Noise Amplifier (LNA) and antenna co-designs have been devised to increase the level of design integration and reduce the receiver noise. In this paper we simulate two such antennas namely F Inverted Compact Antenna (FICA) and Planar Inverted F Antenna (PIFA) and compare their results to obtain the design with better performance.

## Keywords

SDWSN, FICA, PIFA, ESA.

## 1. INTRODUCTION

SDWSNs require a high level of design integration as they comprise of a large number of nodes. Electrically Small Antennas (ESAs) provide a solution to this problem. Two such antennas are FICA and PIFA which have been discussed in this paper. Another requirement of SDWSN is decrement in receiver power consumption and noise. To address this issue LNA has been co-designed with antenna. This LNA is discussed ahead. Further, in this paper FICA and PIFA have been co-designed with LNA. Then their performance has been simulated and their results have been compared.

## 2. F INVERTED COMPACT ANTENNA

It is one of the novel low profile ESAs. It has a very limited ground plane size and the total volume is also very low. This is its major advantage. FICA comprises of two parts, the tapping loop and the helix matching structure. The circuit of FICA shown in Figure 1 has five lumped components.  $L_{ST}$  is the inductance of the shorting stub.  $R_1$  is the radiation resistance and  $L_{FD}$  represents the inductance of the feeding pin. They constitute the tapping loop. The second part consists of  $R_2$  and  $X_2$ . Here  $R_2$  represents ohmic loss of ground plane and antenna. The antenna is actually designed as a short monopole over a ground plane and it has a helical impedance matching transmission line. The radiation efficiency of this FICA is around 48.5%, and if required it can be scaled to lower or higher frequency bands.

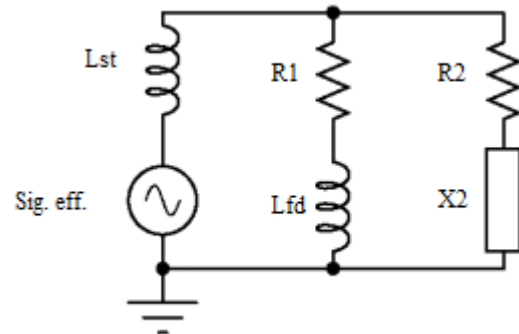


Fig 1: Circuit Model of FICA [B. Yang, 10]

## 3. PLANAR INVERTED F ANTENNA

PIFA is a combination of the inverted F antenna and the patch antenna. It has a wider bandwidth due to the radiating patch. PIFA is a type of patch antenna which is commonly used in cellular phone which have built-in antennas. At quarter wavelength PIFA is resonant. Its design resembles an inverted F. It has been derived from half patch antenna. The length of the shorting plane is reduced which in turn reduces the resonant frequency.

The equivalent circuit comprises of inductance  $L_1$ , capacitance  $C_1$  and conductance  $G_1$ .  $N_1$  represents the electromagnetic coupling.

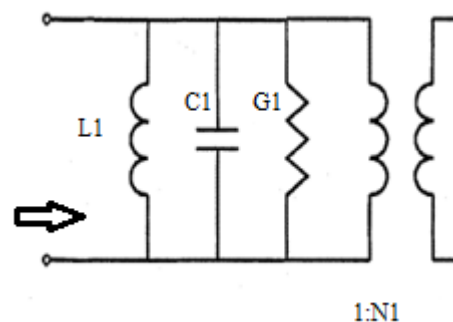


Fig.2. Circuit Model of PIFA [Del Barrio S.C., 11]

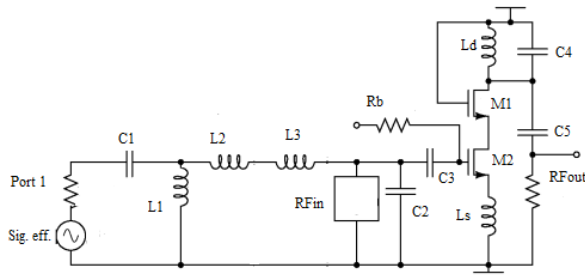
## 4. LOW NOISE AMPLIFIER (LNA)

It is the initial stage of almost all the receiver architectures. It decides the noise level of the system. LNA consumes power to suppress noise and provide gain and linearity. So, active and passive component optimization techniques are employed to develop an efficient high voltage gain cascade LNA. These electronic amplifiers are used for the amplification of very weak signals which are captured by an antenna. Its location is generally based near the detection device in order to reduce

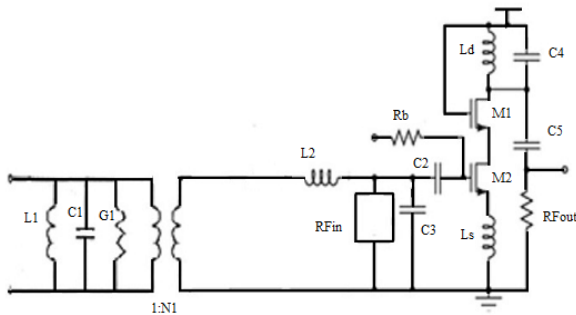
the losses occurring in the feed line. The purpose of using LNA is to minimize the effect of noise from the following stages of the receiver with the help of gain provided by the LNA. For low noise and high amplification transistors such as JFETs are used.

## 5. ANTENNA AND LNA CO-DESIGN

The input matching network of the LNA provides optimum admittance without introducing any extra noise sources in the input signal path, ideally. The bonding wires and the bonding pads appearing at the antenna-LNA interface are also included in the co-design when the antenna and the LNA are integrated. This co-design increases the antenna and system integration and saves chip area. Two circuits have been co-designed in this work using 120 nm technology.



**Fig.3. FICA circuit with co-designed LNA network [B. Yang, 10]**

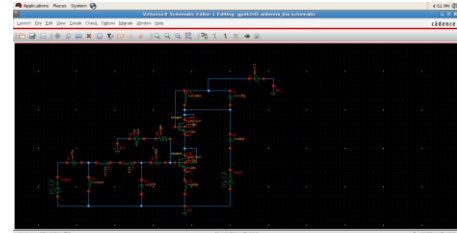


**Fig.4. PIFA circuit with co-designed LNA network [Del Barrio S.C., 11] [B. Yang, 10]**

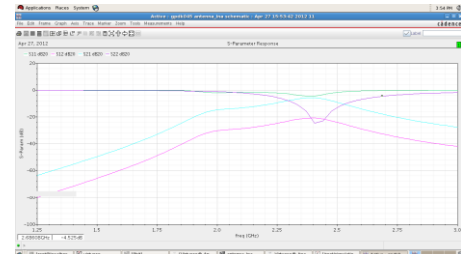
## 6. SIMULATION AND RESULTS

FICA and PIFA-LNA co-designs have been implemented using 120 nm technology. The values of s-parameters, noise figure and noise sensitivity factor have been obtained from the designs and then compared.

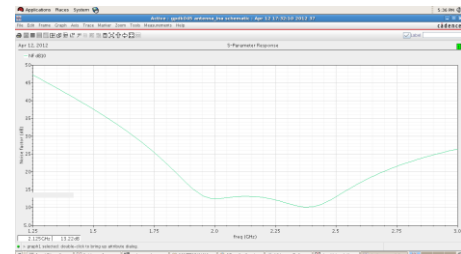
Shown next is the schematic diagram of FICA-LNA co-design implemented on CADENCE VIRTUOSO. Then all the four s-parameters have been obtained for this two port network. Further its immunity to noise is observed. This is done by computing the noise figure and noise sensitivity factor of the co-design.



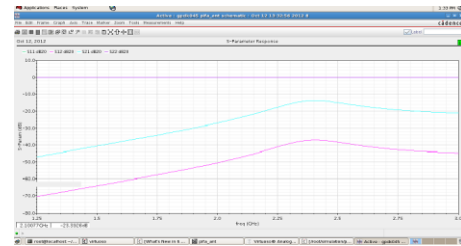
**Fig.5. FICA schematic with LNA Co-Design**



**Fig.6. s-parameters of FICA**

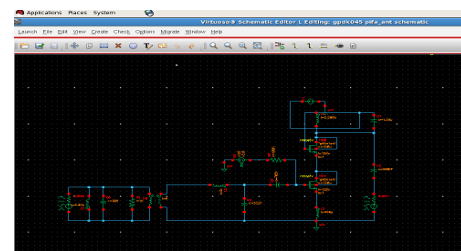


**Fig.7. NF of FICA**



**Fig.8. Rn of FICA**

The figure shown below is the schematic diagram of the PIFA-LNA co-design. This network is then used to compute the desired parameters which help in judging the performance of the design and its immunity to noise.



**Fig.9. Schematic of PIFA- LNA Co-design**

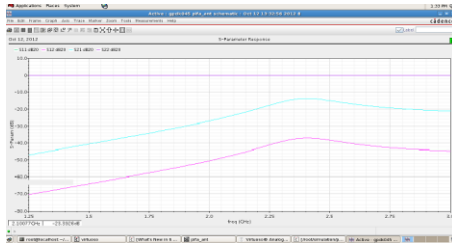


Fig.10. s-parameters of PIFA

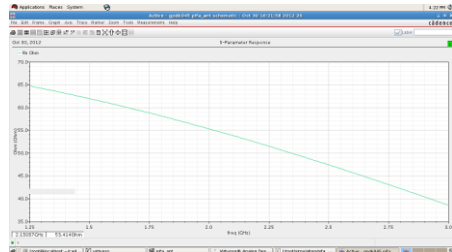


Fig.11. Rn of PIFA

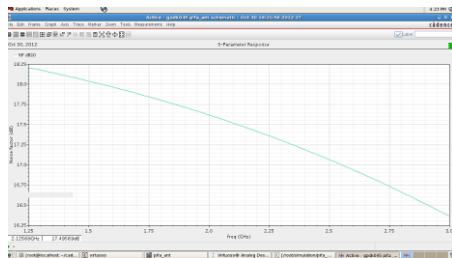


Fig.12. NF of PIFA

Table 1. Comparison table

Parameters	FICA(120nm)	PIFA(120nm)
$S_{11}(\text{max})$	-665.3 $\mu$ db at 1.25165GHz	-32.12 $\mu$ db at 1.25206GHz
$S_{11}(\text{min})$	-4.396db at 2.37238 GHz	-57.826mdb at 2.405GHz
$S_{12}(\text{max})$	-20.854db at 2.41089GHz	-36.905db at 2.4011GHz
$S_{12}(\text{min})$	-79.914db at 1.25167GHz	-70.275db at 1.25069GHz
$S_{21}(\text{max})$	-5.7156db at 2.38833GHz	-13.45307db at 2.4007GHz
$S_{21}(\text{min})$	-63.387db at 1.25167GHz	-46.82116db at 1.25069GHz
$S_{22}(\text{max})$	-38.0892mdb at 1.25167GHz	24.161mdb at 1.25651GHz
$S_{22}(\text{min})$	-24.5454mdb at 2.40476GHz	-44.02mdb at 2.40437GHz
$R_n(\text{max})$	51.0523K $\Omega$ at 1.25172GHz	64.765 $\Omega$ at 1.25068GHz
$R_n(\text{min})$	578.237m $\Omega$ at	38.617 $\Omega$ at 3GHz

	3.405GHz	
$NF_{(\text{max})}$	47.07db at 1.25486GHz	18.20973db at 1.25069GHz
$NF_{(\text{min})}$	10.23db at 2.39451GHz	16.36433db at 3GHz

The results clearly show that FICA exhibits lower reflection coefficients and higher voltage gains as compared to PIFA. Another major parameter that may alter the performance of a network is noise. The results show that FICA is more immune to noise.

## 7. CONCLUSION

These plots and tables show the values for s-parameters, noise figure and noise sensitivity factor for both the designs.  $S_{11}$  gives the values for input port reflection coefficient. The input port reflection coefficients are lower for FICA as compared to PIFA.  $S_{12}$  represents the reverse voltage gain. The value of reverse voltage gain is higher for FICA. FICA gives better result as compared to PIFA.  $S_{22}$  gives the value of output port reflection coefficient. Its value is lower for FICA when compared with PIFA. The plots show that FICA is less sensitive to noise as compared to the PIFA design. FICA yields better results for noise figure as its value for noise figure is lower as compared to that of PIFA. Thus it is concluded that the FICA-LNA co-design yields better performance results when compared with PIFA-LNA co-design.

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